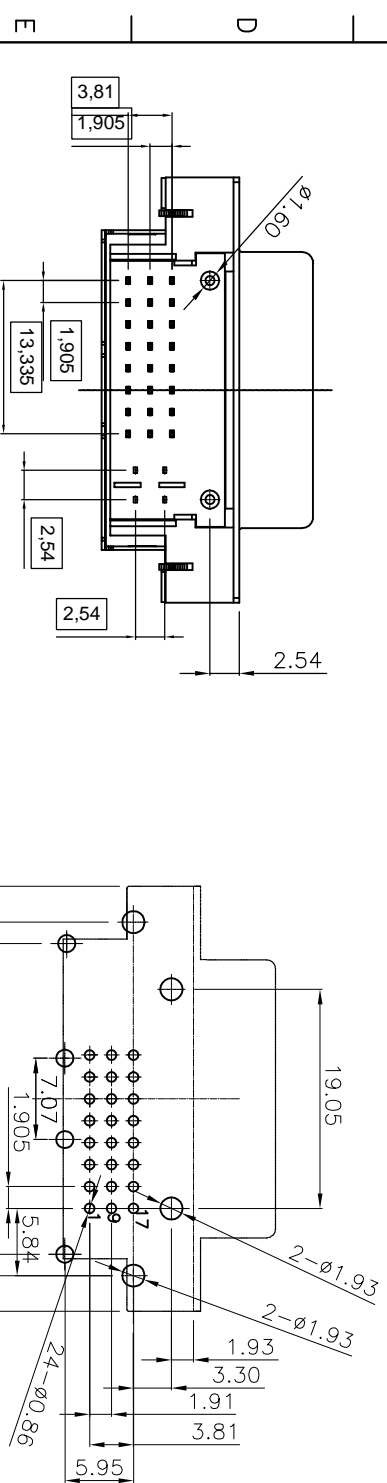


1. HOUSING: THERMOPLASTIC (UL 94V-0).
2. COVER: THERMOPLASTIC (UL 94V-0).
3. TERMINAL: COPPER ALLOY,
GOLD PLATED ON CONTACT AREA,
TIN PLATED ON SOLDER TAILS,
NICKEL UNDER PLATED OVERALL.
4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
5. SHELL: SPCC, NICKEL PLATED OVERALL.
6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.



RECOMMEND PCB LAYOUT
TOLERANCE: ± 0.05
TOP VIEW

TITLE:		24PIN 焊板式 母头+后铁壳
APPD:	Mr.WU	
X. ±0.30	X. ±0.20	
	XX ±0.10	
	XXX±0.05	
DR:	Mr.WU	
X' ±2"		
X' ±1"		
	Gas cheng	
	PART NO:	JTIONS-0030

A	JIONS-DVI-0003		2011/02/01
REV	ECN NO	DESCRIPTION	DATE

Jions 北京玖思启明电子科技有限公司



UNITS: mm	SCALE: 1:1	DWG NO: 客户图 www.jions.com.cn	SHEET:10F
			REV:

SHEET:10F
REV: